

Title (en)
THERMAL PANEL COOLING MODULE

Title (de)
KÜHLMODUL FÜR WÄRMEPLATTE

Title (fr)
MODULE DE REFROIDISSEMENT DE PANNEAU THERMIQUE

Publication
EP 2920524 A2 20150923 (FR)

Application
EP 13801651 A 20131112

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Abstract (en)
[origin: WO2014076405A2] The invention relates to a cooling device (1) for cooling a zone (2) that is to be cooled, the device comprising: - a cooling surface (3) in continuous contact with the zone that is to be cooled (2); - a plurality of strips (4) connected to the surface (3). According to the invention, the device further comprises at least one cooling tube (5) passing through the plurality of strips (4).

IPC 8 full level
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Citation (search report)
See references of WO 2014076405A2

Citation (examination)
• US 6651733 B1 20031125 - HORNG ALEX [TW], et al
• US 2010212868 A1 20100826 - YANG CHIEN-LUNG [US]
• CN 201014945 Y 20080130 - MITAC PREC TECHNOLOGY KUNSHAN [CN]

Designated contracting state (EPC)
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